PCN: PCN\_KSM26RD4\_32MEI\_P Date: August 3, 2020 Kingston Technology Company 17600 Newhope Street Fountain Valley, CA 92708 USA

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Type of Change:	Phase Out for End of Life
Product Affected:	KSM26RD4/32MEI
Product Description:	32GB DDR4-2666 Registered DIMM CL19 2Rx4 1.2V Micron E Die w/IDT (Server Premier)
Description of Change:	Phase out due to supplier DRAM density transition. Replacement and alternate parts available.
Replacement Part:	KSM26RD4/32HDI 32GB DDR4-2666 Registered DIMM CL19 2Rx4 1.2V <u>Hynix D</u> Die w/IDT (Server Premier)
Alternate Parts:	KSM26RS4/32MEI 32GB DDR4-2666 Registered DIMM CL19 <u>1R</u> x4 1.2V <u>Micron E</u> Die w/IDT (Server Premier)
	KSM26RD8/32MEI 32GB DDR4-2666 Registered DIMM CL19 2R <u>x8</u> 1.2V <u>Micron E</u> Die w/IDT (Server Premier)
	KSM26RS4/32HAI 32GB DDR4-2666 Registered DIMM CL19 <u>1R</u> x4 1.2V <u>Hynix A</u> Die w/IDT (Server Premier)
	KSM26RD8/32HAI 32GB DDR4-2666 Registered DIMM CL19 2R <u>x8</u> 1.2V <u>Hynix A</u> Die w/IDT (Server Premier)
	NOTE: Alternate parts built with 16Gb density DRAM require a compatible server platform to used.
Phase Out Notice:	August 3, 2020
Target EOL Date:	November 2, 2020 *
	* An increase in demand may cause the EOL date to be pulled in. Please contact your Kingston representative to forecast and assist with replacement part qualification.

Please contact your Kingston Sales Representative for further information.

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